LM380
2.5W Audio Power Amplifier

General Description
The LM380 is a power audio amplifier for consumer applications. In order to hold system cost to a minimum, gain is internally fixed at 34 dB. A unique input stage allows ground referenced input signals. The output automatically self-centers to one-half the supply voltage. The output is short circuit proof with internal thermal limiting. The package outline is standard dual-in-line. The LM380N uses a copper lead frame. The center three pins on either side comprise a heat sink. This makes the device easy to use in standard PC layouts. Uses include simple phonograph amplifiers, intercoms, line drivers, teaching machine outputs, alarms, ultrasonic drivers, TV sound systems, AM-FM radio, small servo drivers, power converters, etc.

Features
- Wide supply voltage range: 10V-22V
- Low quiescent power drain: 0.13W (V_S = 18V)
- Voltage gain fixed at 50
- High peak current capability: 1.3A
- Input referenced to GND
- High input impedance: 150kΩ
- Low distortion
- Quiescent output voltage is at one-half of the supply voltage
- Standard dual-in-line package

Connection Diagrams (Dual-In-Line Packages, Top View)
Block and Schematic Diagrams

LM380N

+ VOUT
  +14
  -8
  -7
  -6
  -5
  -4
  -3
  -2

IN
  +1
  -2

BYPASS
  -1

GND
  -6

3, 4, 5, 10, 11, 12

LM380N-8

+ VOUT
  +8
  -7
  -6

IN
  +3
  -4

BYPASS
  -1

GND
  -6

3, 4, 5, 10, 11, 12

LM380

VOUT (14)

BYPASS (1)

-1N (6)

150K

25K

1K

10 pF

150K

GND (7)

GND (2)
### Absolute Maximum Ratings (Note 1)

If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/Distributors for availability and specifications.

- **Supply Voltage**: 22V
- **Peak Current**: 1.3A
- **Package Dissipation 14-Pin DIP (Note 7)**: 8.3W
- **Package Dissipation 8-Pin DIP (Note 7)**: 1.67W
- **Input Voltage**: ±0.5V
- **Storage Temperature**: −65˚C to +150˚C

#### Operating Temperature
- **0˚C to +70˚C**

#### Junction Temperature
- **+150˚C**

#### Lead Temperature (Soldering, 10 sec.)
- **+260˚C**

#### ESD Rating
- **To be determined**

#### Temperature Coefficient
- **θJC (14-Pin DIP)**: 30˚C/W
- **θJC (8-Pin DIP)**: 37˚C/W
- **θJA (14-Pin DIP)**: 79˚C/W
- **θJA (8-Pin DIP)**: 107˚C/W

### Electrical Characteristics (Note 2)

<table>
<thead>
<tr>
<th>Symbol</th>
<th>Parameter</th>
<th>Conditions</th>
<th>Min</th>
<th>Typ</th>
<th>Max</th>
<th>Units</th>
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</thead>
<tbody>
<tr>
<td>P_{OUT(RMS)}</td>
<td>Output Power</td>
<td>( R_L = 8\Omega, ) THD = 3% (Notes 4, 5)</td>
<td>2.5</td>
<td></td>
<td></td>
<td>W</td>
</tr>
<tr>
<td>( A_V )</td>
<td>Gain</td>
<td></td>
<td>40</td>
<td>50</td>
<td>60</td>
<td>V/V</td>
</tr>
<tr>
<td>V_{OUT}</td>
<td>Output Voltage Swing</td>
<td>( R_L = 8\Omega )</td>
<td>14</td>
<td></td>
<td></td>
<td>V_{p-p}</td>
</tr>
<tr>
<td>Z_{IN}</td>
<td>Input Resistance</td>
<td></td>
<td>150k</td>
<td></td>
<td></td>
<td>Ω</td>
</tr>
<tr>
<td>THD</td>
<td>Total Harmonic Distortion</td>
<td>(Notes 5, 6)</td>
<td>0.2</td>
<td></td>
<td></td>
<td>%</td>
</tr>
<tr>
<td>PSRR</td>
<td>Power Supply Rejection Ratio</td>
<td>(Note 3)</td>
<td>38</td>
<td></td>
<td></td>
<td>dB</td>
</tr>
<tr>
<td>V_S</td>
<td>Supply Voltage</td>
<td></td>
<td>10</td>
<td></td>
<td>22</td>
<td>V</td>
</tr>
<tr>
<td>BW</td>
<td>Bandwidth</td>
<td>( P_{OUT} = 2W, R_L = 8\Omega )</td>
<td>100k</td>
<td></td>
<td></td>
<td>Hz</td>
</tr>
<tr>
<td>I_Q</td>
<td>Quiescent Supply Current</td>
<td></td>
<td>7</td>
<td>25</td>
<td></td>
<td>mA</td>
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<tr>
<td>V_{OUTQ}</td>
<td>Quiescent Output Voltage</td>
<td></td>
<td>8</td>
<td>9.0</td>
<td>10</td>
<td>V</td>
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<tr>
<td>I_{BIAS}</td>
<td>Bias Current</td>
<td>Inputs Floating</td>
<td>100</td>
<td></td>
<td></td>
<td>nA</td>
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<td>I_{SC}</td>
<td>Short Circuit Current</td>
<td></td>
<td>1.3</td>
<td></td>
<td></td>
<td>A</td>
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</tbody>
</table>

**Note 1:** “Absolute Maximum Ratings” indicate limits beyond which damage to the device may occur. Operating Ratings indicate conditions for which the device is functional, but do not guarantee specific performance limits.

**Note 2:** \( V_S = 18V \) and \( T_A = 25˚C \) unless otherwise specified.

**Note 3:** Rejection ratio referred to the output with \( C_{BYPASS} = 5 \mu F \).

**Note 4:** With device Pins 3, 4, 5, 10, 11, 12 soldered into a 1/16” epoxy glass board with 2 ounce copper foil with a minimum surface of 6 square inches.

**Note 5:** \( C_{BYPASS} = 0.47 \mu F \) on Pin 1.

**Note 6:** The maximum junction temperature of the LM380 is 150˚C.

**Note 7:** The package is to be derated at 15˚C/W junction to heat sink pins for 14-pin pkg; 75˚C/W for 8-pin.
Heat Sink Dimensions

Copper Wings
2 Required
Soldered to
Pins 3, 4, 5,
10, 11, 12
Thickness 0.04
Inches

Typical Performance Characteristics

Maximum Device Dissipation vs Ambient Temperature

Device Dissipation vs Output Power — 4Ω Load

Note: 2 oz. copper foil, single-sided PC board.
Typical Performance Characteristics (Continued)

Device Dissipation vs Output Power — 8Ω Load

Device Dissipation vs Output Power — 16Ω Load

Power Supply Current vs Supply Voltage

Total Harmonic Distortion vs Frequency

Output Voltage Gain and Phase vs Frequency

Total Harmonic Distortion vs Output Power
Typical Performance Characteristics  (Continued)

Device Dissipation vs Output Power

Supply Decoupling vs Frequency

Typical Applications

Phono Amplifier

Bridge Amplifier
Typical Applications (Continued)

**Intercom**

*FOR STABILITY WITH HIGH CURRENT LOADS

**Phase Shift Oscillator**

f = 4 kHz
Molded Dual-In-Line Package (N)
Order Number LM380N-8
NS Package Number N08E
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2. A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

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